IEEE Andescon
TECHNOLOGY AND INNOVATION FOR ANDEAN INDUSTRY

16 – 19 November, 2022
Barranquilla, Colombia

IEEE consejoandino

IEEE — Advancing Technology for Humanity

IMPORTANT DATES

Deadline for Papers Submission:
June 12th, 2022

Notification of Acceptance:
July 31th, 2022

Camera Ready Submissions:
September 4th, 2022

CONFERENCE DATES

16 – 19 November, 2022
Barranquilla, Colombia

CONFERENCE SITE

https://attend.ieee.org/andescon

ORGANIZED BY

IEEE ColCaribe — Colombian Caribbean Section

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CALL FOR PAPERS

ANDESCON is the biannual Technical and Scientific Conference of the Andean Council of the IEEE that brings together IEEE professionals and scientists from the Andean countries. The eleventh edition of this IEEE event will be held in the wonderful city of Barranquilla in Colombia. The ANDESCON conference is an opportunity for professional members, academics, researchers and industrialists to meet and present the developments and technological advances that move the Andean region countries.
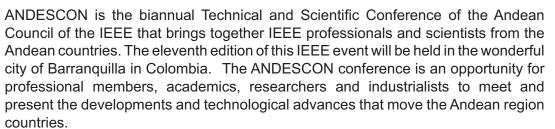
IEEE ANDESCON 2022 will be held in person if COVID-19 emergency allows that. In that case, a special room for remote presentations will be enabled.

TRACKS AND TOPICS

The conference covers both theoretical and practical issues related to, but not limited to:

- Circuits, Systems and Electron Devices
- Communications
- Computational Intelligence
- Computer and Software Engineering
- Education in Engineering
- Power and Energy
- Robotics and Automation Systems
- Signal Processing & Aerospace and Electronic Systems
- Smart Cities
- Systems and Control
- Technology & Engineering Management

PAPER SUBMISSION

The articles must be submitted in digital format (PDF) through the paper submission page. Papers must be written in English using the IEEE conference format. The maximum length is six (6) pages per article including illustrations and references. Each paper should indicate appropriateness for the scope of the Conference, originality and quality of the technical content, whole organization and writing style. Accepted papers will be published in the conference proceedings and submitted for inclusion in the IEEE Xplore Digital Library. All previous ANDESCON editions that meet the SCOPUS guidelines have been included in this index.

For each accepted paper, at least one of the authors must register and present the paper at the conference; no-show paper will not be submitted for inclusion in IEEE Xplore. All papers will be cross-examined using anti-plagiarism automated software tools.